

CA7T-9W

Product Code: KVXP-3570xxH

Table of Contents

REVISION HISTORY	1
ABSOLUTE MAXIMUM RATING	2
PRODUCT CHARACTERISTICS	2
FLUX CHARACTERISTICS	3
RELATIVE SPECTRAL POWER DISTRIBUTION .	4
ELECTRICAL CHARACTERISTIC	5
RELATIVE LUMINOUS FLUX VS. CURRENT	5
TYPICAL SPATIAL DISTRIBUTION	6
PERFORMANCE GROUPS	7
GPI'S STANDARD WHITE CHROMATICITY	REGINS
PLOTTED ON THE 1931 CIE CURVE	8
RELIABILITY	9
REFLOW SOLDERING CHARACTERISTICS	9
MECHANICAL DIMENSIONS	10
TAPE AND REEL	11
PACKING	12
CAUTIONS	13

Doc. ID: PKG-DS-065 Rev. D Date: April 11, 2019



REVISION HISTORY

Rev.	Date	Charged	Approved	Revision Summary
А	2017/12/08	Frank	Bruce	First issue
В	2018/01/25	Frank	Bruce	Revised: 1. Photo 2. Product Code 3. ABSOLUTE MAXIMUM RATING (Tj= 85 °C) 4. PRODUCT CHARACTERISTICS 5. FLUX CHARACTERISTICS (Tj = 85 °C) 6. RELATIVE SPECTRAL POWER DISTRIBUTION 7. ELECTRICAL CHARACTERISTIC (Tj = 85 °C) 8. RELATIVE LUMINOUS FLUX VS. CURRENT (Tj= 85 °C) 9. PERFORMANCE GROUPS – BRIGHTNESS (Tj = 85 °C) 10. PERFORMANCE GROUPS – CHROMATICITY 11. GPI'S STANDARD WHITE CHROMATICITY REGINS PLOTTED ON THE 1931 CIE CURVE 12. RELIABILITY 13. MECHANICAL DIMENSIONS 14. TAPE AND REEL 15. PACKING
С	2018/05/10	Frank	Bruce	Revised: 1. Product Code 2. ABSOLUTE MAXIMUM RATING 3. PRODUCT CHARACTERISTICS 4. FLUX CHARACTERISTICS 5. ELECTRICAL CHARACTERISTIC 6. RELATIVE LUMINOUS FLUX VS. CURRENT 7. PERFORMANCE GROUPS – BRIGHTNESS 8. PERFORMANCE GROUPS – FORWARD VOLTAGE 9. RELIABILITY
D	2019/04/11	Frank	Bruce	Revised: 1. Photo 2. Product Code 3. ABSOLUTE MAXIMUM RATING (Tj= 85 °C) 4. PRODUCT CHARACTERISTICS 5. FLUX CHARACTERISTICS 6. RELATIVE SPECTRAL POWER DISTRIBUTION 7. ELECTRICAL CHARACTERISTIC 8. RELATIVE LUMINOUS FLUX VS. CURRENT 9. PERFORMANCE GROUPS – BRIGHTNESS 10. MECHANICAL DIMENSIONS 11. PERFORMANCE GROUPS – CHROMATICITY 12. GPI's STANDARD WHITE CHROMATICITY REGINS PLOTTED ON THE 1931 CIE CURVE

| 1



ABSOLUTE MAXIMUM RATING

Characteristics	Value	Unit
DC Forward Current	1800	mA
DC Reverse Voltage	12	V
Storage Temperature	-40 ~ 125	°C
Operating Temperature	-40 ~ 125	°C
LED Junction Temperature	150	°C

PRODUCT CHARACTERISTICS

Characteristics	Unit	minimum	Тур.	Maximum
Thermal resistance, junction to solder point	°C /W		2.5	
Viewing Angle (FWHM)	degrees		115	
Temperature coefficient of voltage	mV/°C		-2.5	
DC Forward Current	mA		1600	1800
Reverse Voltage	V			12
Forward Voltage	V		9.6	10.2
LED junction temperature	°C			150

| 2



FLUX CHARACTERISTICS

Color	ССТ		Base Order codes Minimum Luminous Flux (Im)		Calculated Minimum Luminous Flux (Im)*	Order Code	
Min Max	Max	Group	1600mA	1800mA			
			H15	1500	1650		
Ra 70, Cool White	5400	7000	H16	1600	1760	KVXP-3570C7H	
			H17	1700	1870		

Wd Color		Vd	Base Order codes Minimum Luminous Flux (Im)		Calculated Minimum Luminous Flux (Im)*	Order Code	
	Min	Мах	Group	1600mA	1800mA		
Selective	676	EQE	H14	1400	1540		
Yellow 575	575 585	H15	1500	1650	KVXP-3570SYH		

Notes:

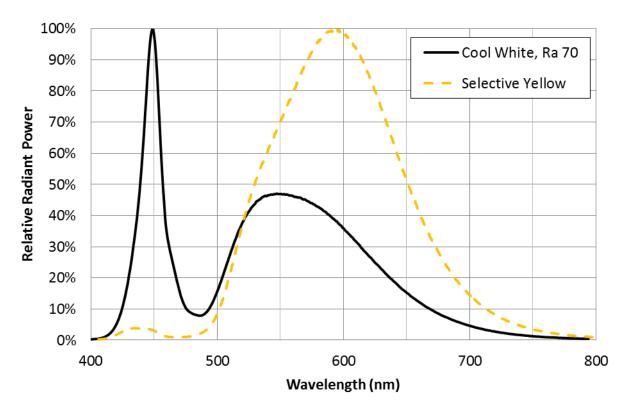
• GPI maintains a tolerance of $\pm 5\%$ on flux and power measurements, ± 0.005 on chromaticity (CCx, CCy) measurements and ± 2 on Ra measurements.

Calculated flux values are for reference only.

| 3



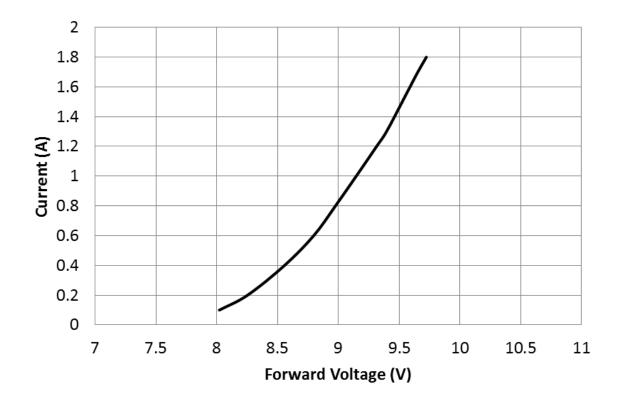
RELATIVE SPECTRAL POWER DISTRIBUTION



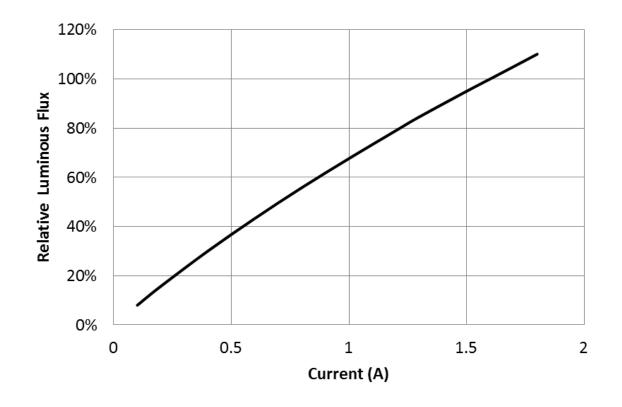
| 4



ELECTRICAL CHARACTERISTIC



RELATIVE LUMINOUS FLUX VS. CURRENT

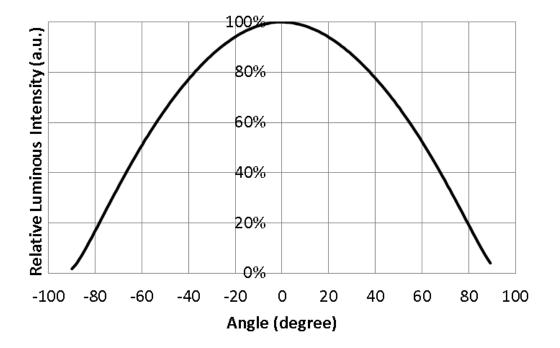


PKG-DS-065 Rev. D

| 5



TYPICAL SPATIAL DISTRIBUTION



| 6



PERFORMANCE GROUPS – BRIGHTNESS

Group code	Min. Luminous Flux (Im)	Max. Luminous Flux (Im)
H14	1400	1500
H15	1500	1600
H16	1600	1700
H17	1700	1800

PERFORMANCE GROUPS – FORWARD VOLTAGE

Group code	Minimum Forward Voltage (V)	Maximum Forward Voltage (V)
KE	8.4	9.0
KF	9.0	9.6
KG	9.6	10.2

PERFORMANCE GROUPS – CHROMATICITY

Bin Code	x	У	Bin Code	x	у
	0.32	0.3511		0.32	0.3511
M40	0.3108	0.344	MOO	0.329	0.3581
M10	0.3108	0.305	M20	0.329	0.3231
	0.32	0.3141		0.32	0.3141

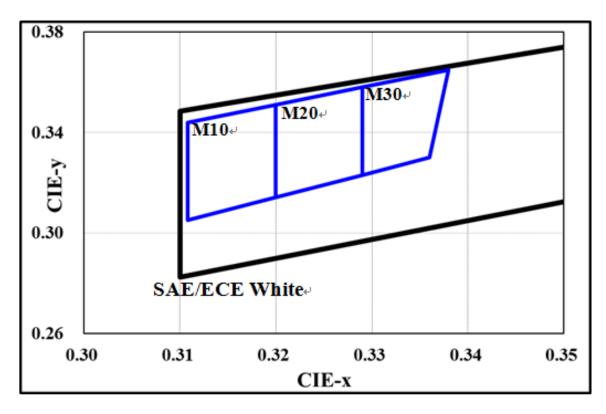
Bin Code	x	У
M30	0.329	0.3581
	0.338	0.365
	0.336	0.33
	0.329	0.3231

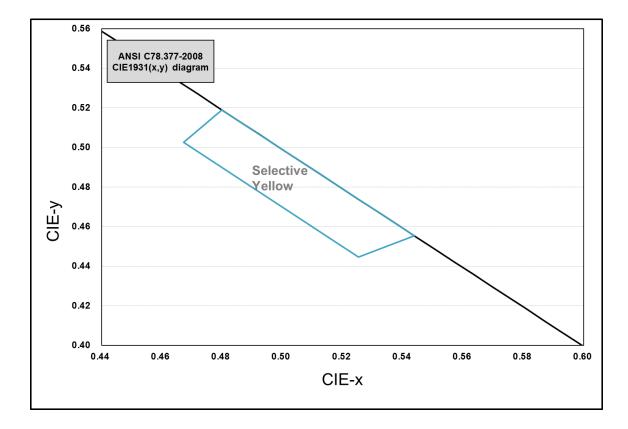
Bin Code	x	У
Selective Yellow	0.5438	0.4554
	0.5253	0.4447
	0.4673	0.5028
	0.4799	0.5190

| 7



GPI's STANDARD WHITE CHROMATICITY REGINS PLOTTED ON THE 1931 CIE CURVE





www.gpiled.com

| 8



RELIABILITY

Test Item	Test Conditions		Test Period	Ac/Re
Room Temperature Operating Life (RTOL)	IF=1800mA DC		1000hrs	0/1
Wet High Temperature Operating Life(WHTOL)	TA=85°C;85% humidity IF=1800mA DC		1000hrs	0/1
High Temperature Operating Life (HTOL)	TA=85°C;IF=1800mA DC		1000hrs	0/1
Thormal Cyclo	-40 ℃	125℃	1000 ovolo	0/1
Thermal Cycle	30min	30 min	— 1000 cycle	0/1
Reflow Soldering	Tmax.=260℃		3 times	0/1

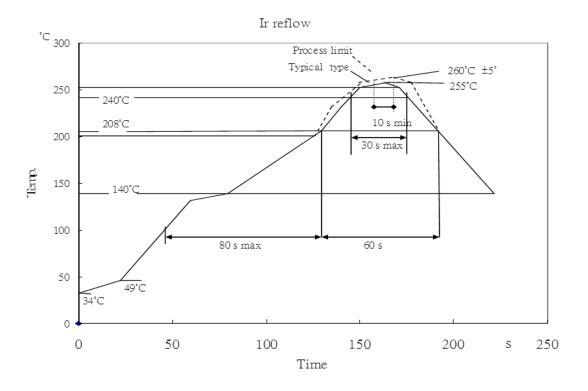
Notes:

- No catastrophic (LED Fail)
- Lumen maintenance > 90%
- Change in Vf < 10%
- Change in white color point $\Delta x \Delta y \pm 0.01$

No corrosion

Moisture Sensitivity Level 2 (IPC/JEDEC J-STD-020)

Reflow Soldering Characteristics

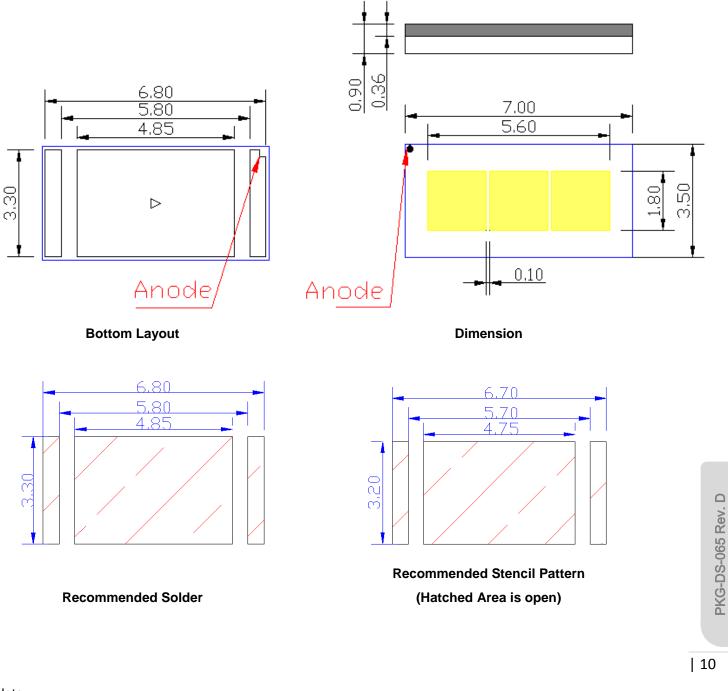


PKG-DS-065 Rev. D

| 9



MECHANICAL DIMENSIONS



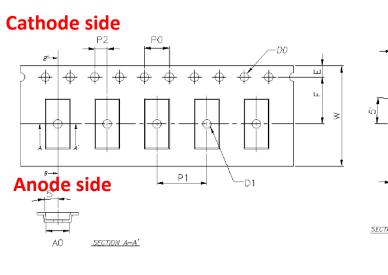
- Note:
- Dimensions are in millimeters. ± 0.13 1.
- 2. Measurement tolerances :



1

TAPE AND REEL



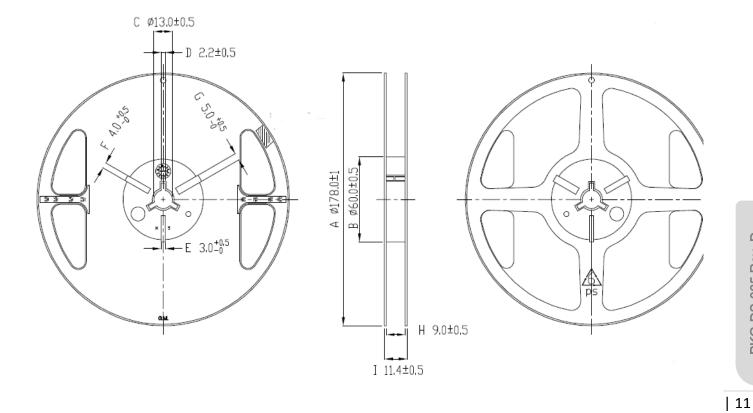


	Item	Specification	Tol. (+/-)
BO	W	16.00	± 0.30
	Е	1.75	± 0.10
	F	7.50	± 0.10
	D0	1.50	+0.10,-0
	D1	1.50	± 0.10
	P0	4.00	± 0.10
	P1	8.00	± 0.10
	P2	2.00	± 0.10
	P0 x 10	40.00	± 0.20

10N B-B	t
	A0
	B0

KΟ

t	0.30	± 0.05
A0	3.80	± 0.10
B0	7.80	± 0.10
K0	1.20	± 0.10

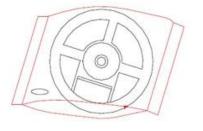


Note:

• Dimension unit: millimeter.

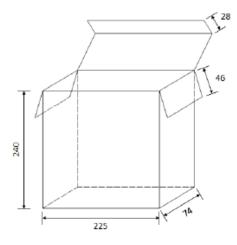
PACKING



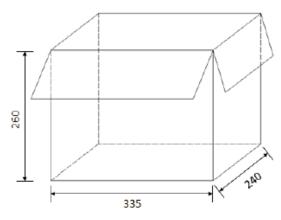


1 Anti-Static Reel in 1 Moistureproof Foil Bag.

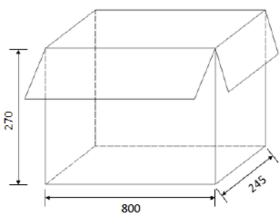
(Within Moisture Absorbent Material)



5 Moistureproof Foil Bags in Box.



28 Moistureproof Foil Bags in Box.



68 Moistureproof Foil Bags in Box.

| 12



CAUTIONS

1. Moisture Sensitivity

In testing, GPI has found CA7T-9W LEDs to have 1 year floor life in condition <=30C/ 60% relative humidity (RH). Moisture testing included a 168-hr soak at 85C/60% RH followed by 3 times reflow cycles, with visual and electrical inspections at each stage.

GPI recommends keeping CA7T-9W LEDs in their sealed moisture-barrier packaging until immediately prior to use. GPI also recommends returning any unusual LEDs to the re-sealable moisture-barrier bag and closing the bag immediately after use.

2. Handling Precautions

Do not handle LEDs with bare hands, it may contaminate the LED surface and affect optical characteristics. In the worst case, catastrophic failure from excess pressure through wire-bond breaks and package damage may result.

Do not stack assembled PCBs together. Failure to comply can cause the resin portion of the product to be cut, chipped, delaminated and/or deformed. It may cause wire to break, leading to catastrophic failures.

3. Eye safety

Warning: do not look at exposed lamp in operation. Eye injury can result.

4. Static Electricity

Wristbands and anti-electrostatic gloves are strongly recommended and all devices, equipment and machinery must be properly grounded when handling the LEDs, which are sensitive against static electricity and surge.

Precautions are to be taken against surge voltage to the equipment that mounts the LEDs. Unusual characteristics such as significant increase of current leakage, decrease of turn-on voltage or non-operation at a low current can occur when the LED is damaged.

5. Thermal Constraints

The temperature of the package surface is strongly recommended below 150 $^\circ\!C$ in operation. | 13